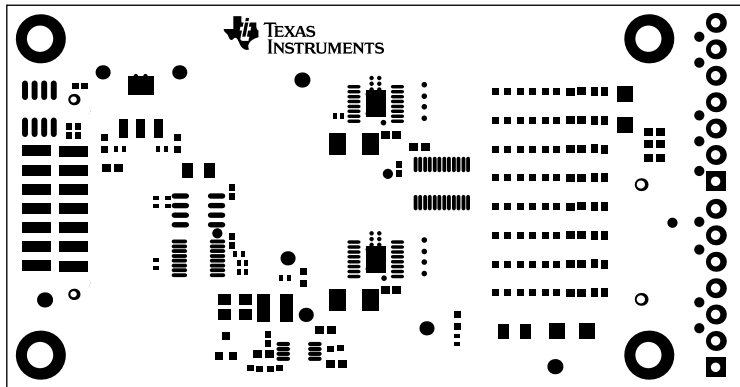
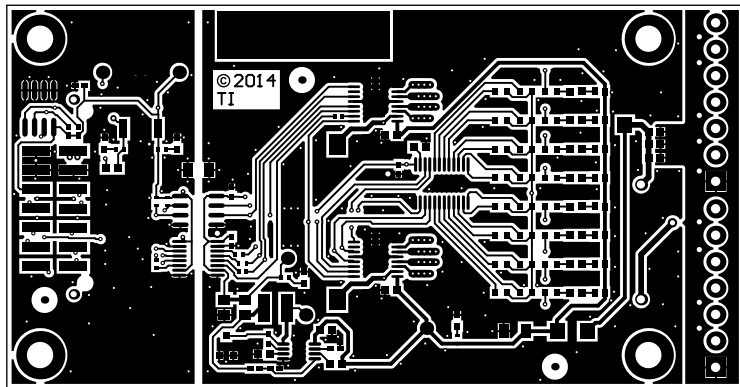


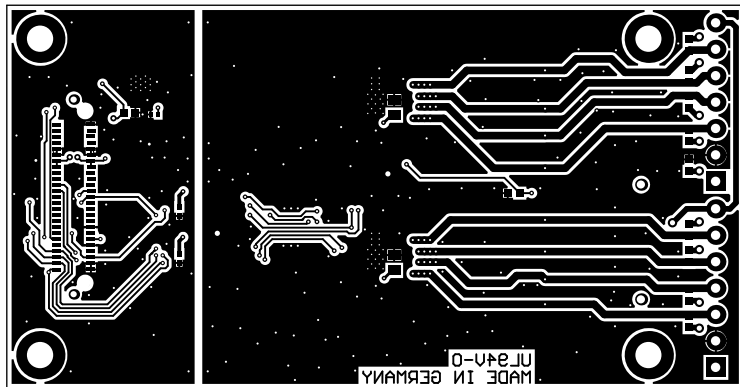
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 9/12/2014 10:47:48 AM	TEXAS INSTRUMENTS	



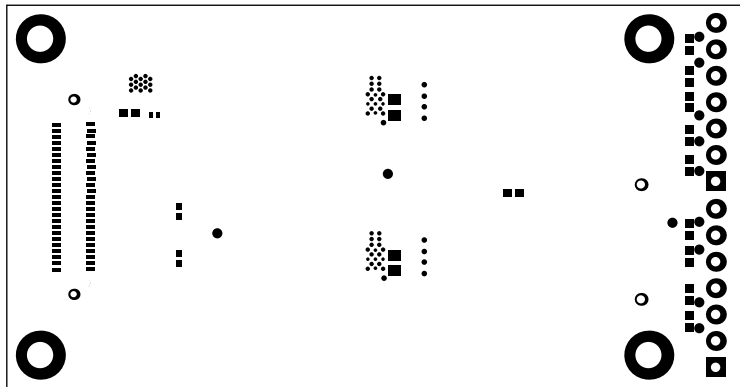
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 9/12/2014 10:47:49 AM	TEXAS INSTRUMENTS	



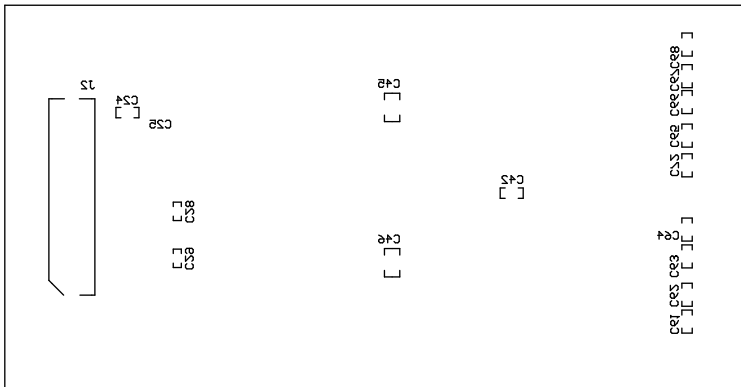
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 9/12/2014 10:47:51 AM	TEXAS INSTRUMENTS	



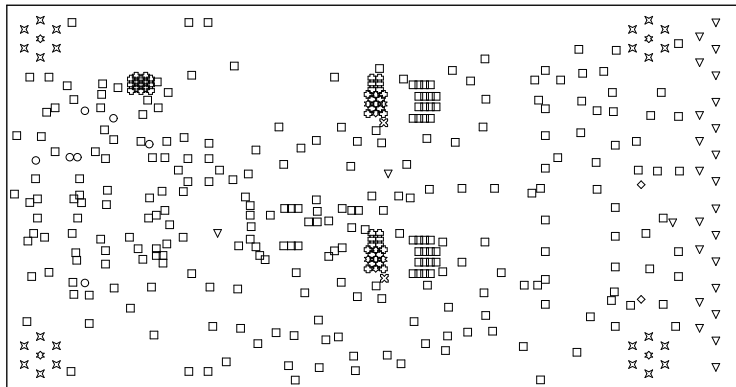
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/12/2014 10:47:52 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/12/2014 10:47:53 AM	TEXAS INSTRUMENTS	



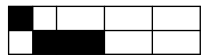
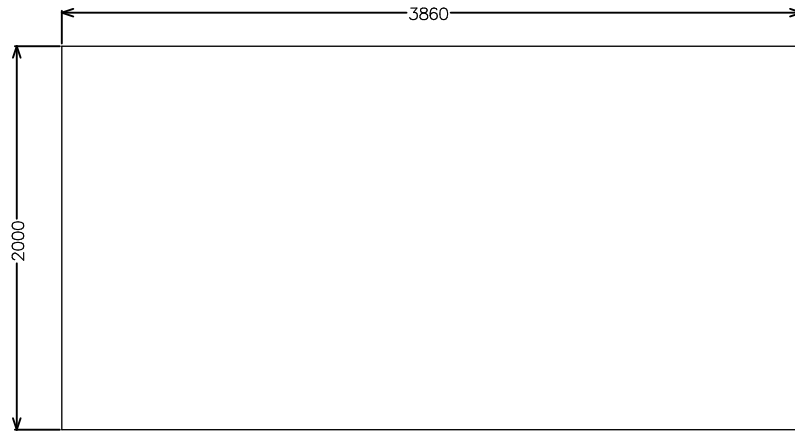
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 9/12/2014 10:47:54 AM	TEXAS INSTRUMENTS	



Drill Table

Symbol	Hit Count	Tool Size	Plated	Hole Type
*	10	7.874mil (0.2mm)	PTH	Round
⊗	43	8mil (0.203mm)	PTH	Round
⊗	2	10mil (0.254mm)	PTH	Round
□	274	12mil (0.305mm)	PTH	Round
○	5	16mil (0.406mm)	PTH	Round
⊗	24	19.685mil (0.5mm)	PTH	Round
▽	12	28mil (0.711mm)	PTH	Round
□	2	33mil (0.838mm)	PTH	Round
◇	2	43.307mil (1.1mm)	PTH	Round
▽	14	50mil (1.27mm)	PTH	Round
○	2	57.087mil (1.45mm)	NPTH	Round
*	4	137.795mil (3.5mm)	PTH	Round
	<b>394 Total</b>			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/12/2014 10:47:56 AM	TEXAS INSTRUMENTS	



←1000 (mil)→

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00236	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/12/2014 10:47:57 AM	TEXAS INSTRUMENTS	



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